

# APPLICATION DATA SHEET

Electronic Version 0.0.11

Stylesheet Version: 1.0 Attorney Docket Number: 740107-173  
Publication Filing Type: new-utility  
Application Type: utility  
Title of Invention: DIE BONDER

Legal Representative:

Attorney or Agent: David S. Safran  
Registration Number: 27997

Customer Number Correspondence Address: 22204

\*22204\*

Foreign Priority:

2002-271266 JP 2002-09-18 Priority Claimed

Assignee (Publish): Tokyo Seimitsu Co., Ltd.  
7-1, Shimorenjaku 9-chome,  
Mitaka-shi, Tokyo JP

INVENTOR(s):

Primary Citizenship: JAPAN  
Given Name: Yuichi  
Family Name: KUBO  
Residence City: Mitaka-shi  
Residence Country: JP  
Address: c/o Tokyo Seimitsu Co., Ltd.  
7-1, Shimorenjaku 9-chome,  
Mitaka-shi Tokyo, JP

Primary Citizenship: JAPAN  
Given Name: Masateru  
Family Name: OSADA  
Residence City: Mitaka-shi

Residence Country: JP  
Address: c/o Tokyo Seimitsu Co., Ltd.  
7-1, Shimorenjaku 9-chome,  
Mitaka-shi Tokyo, JP

Primary Citizenship: JAPAN  
Given Name: Masayuki  
Family Name: AZUMA  
Residence City: Mitaka-shi  
Residence Country: JP  
Address: c/o Tokyo Seimitsu Co., Ltd.  
7-1, Shimorenjaku 9-chome,  
Mitaka-shi Tokyo, JP